



SamHop Microelectronics Corp.



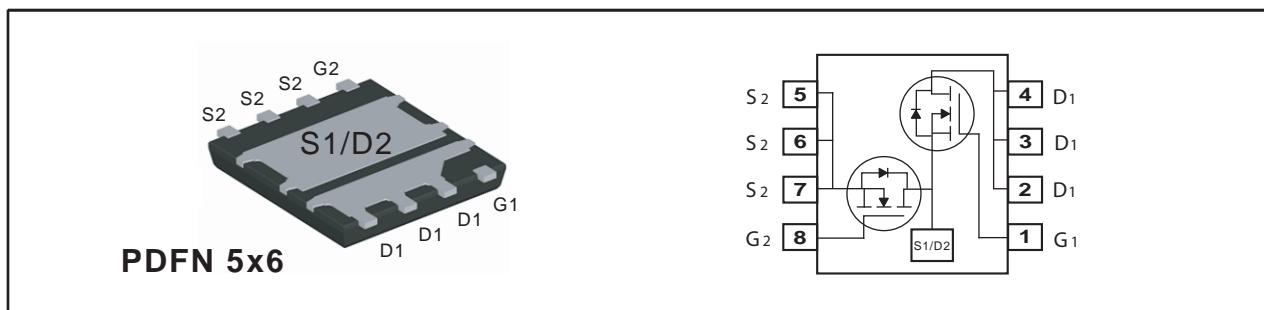
SP4810

Ver 1.0

Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY (DIE 1)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
40V	40A	15 @ V _{GS} =10V
		20 @ V _{GS} =4.5V

PRODUCT SUMMARY (DIE 2)		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
40V	54A	10 @ V _{GS} =10V
		15 @ V _{GS} =4.5V

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Symbol	Parameter	Die 1	Die 2	Units
V _{DS}	Drain-Source Voltage	40		V
V _{GS}	Gate-Source Voltage		±20	V
I _D	Drain Current-Continuous ^b	T _C =25°C	40	A
		T _C =70°C	32	A
I _{DM}	-Pulsed ^b	89	94	A
E _{AS}	Sigle Pulse Avalanche Energy ^c	81	121	mJ
P _D	Maximum Power Dissipation	T _C =25°C	42	W
		T _C =70°C	27	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 to 150		°C

THERMAL CHARACTERISTICS

R _{θJC}	Thermal Resistance, Junction-to-Case	3	2	°C/W
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Details are subject to change without notice.

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DIE 1 - ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	40			V
Idss	Zero Gate Voltage Drain Current	$V_{DS}=32\text{V}$, $V_{GS}=0\text{V}$			1	μA
IGSS	Gate-Body Leakage Current	$V_{GS}= \pm 20\text{V}$, $V_{DS}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1	1.5	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	$V_{GS}=10\text{V}$, $I_D=10\text{A}$		12	15	m ohm
		$V_{GS}=4.5\text{V}$, $I_D=8.5\text{A}$		15	20	m ohm
g _{FS}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_D=10\text{A}$		31		S
DYNAMIC CHARACTERISTICS ^a						
C _{ISS}	Input Capacitance	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$		662		pF
C _{OSS}	Output Capacitance			121		pF
C _{RSS}	Reverse Transfer Capacitance			95		pF
SWITCHING CHARACTERISTICS ^a						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=20\text{V}$ $I_D=1\text{A}$ $V_{GS}=10\text{V}$ $R_{GEN}= 6 \text{ ohm}$		13		ns
t _r	Rise Time			16		ns
t _{D(OFF)}	Turn-Off Delay Time			38		ns
t _f	Fall Time			9		ns
Q _g	Total Gate Charge	$V_{DS}=20\text{V}, I_D=10\text{A}, V_{GS}=10\text{V}$		12		nC
		$V_{DS}=20\text{V}, I_D=10\text{A}, V_{GS}=4.5\text{V}$		6.2		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=20\text{V}, I_D=10\text{A},$ $V_{GS}=10\text{V}$		1.3		nC
Q _{gd}	Gate-Drain Charge			3.7		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=3\text{A}$		0.78	1.2	V
Notes						
a.Guaranteed by design, not subject to production testing.						
b.Drain current limited by maximum junction temperature.						
c.Starting $T_J=25^\circ\text{C}$, $L=0.5\text{mH}$, $V_{DD}= 20\text{V}$. (See Figure13)						
d.Mounted on FR4 Board of 1 inch ² , 2oz.						

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DIE 2 - ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	40			V
Idss	Zero Gate Voltage Drain Current	$V_{DS}=32\text{V}$, $V_{GS}=0\text{V}$			1	μA
IGSS	Gate-Body Leakage Current	$V_{GS}= \pm 20\text{V}$, $V_{DS}=0\text{V}$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1	1.6	3	V
R _{DS(ON)}	Drain-Source On-State Resistance	$V_{GS}=10\text{V}$, $I_D=13.5\text{A}$		8	10	m ohm
		$V_{GS}=4.5\text{V}$, $I_D=11\text{A}$		11	15	m ohm
g _{FS}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_D=13.5\text{A}$		22		S
DYNAMIC CHARACTERISTICS ^a						
C _{ISS}	Input Capacitance	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$		1414		pF
C _{OSS}	Output Capacitance			170		pF
C _{RSS}	Reverse Transfer Capacitance			146		pF
SWITCHING CHARACTERISTICS ^a						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=20\text{V}$ $I_D=1\text{A}$ $V_{GS}=10\text{V}$ $R_{GEN}=6\text{ ohm}$		23		ns
t _r	Rise Time			27		ns
t _{D(OFF)}	Turn-Off Delay Time			68		ns
t _f	Fall Time			38		ns
Q _g	Total Gate Charge	$V_{DS}=20\text{V}, I_D=13.5\text{A}, V_{GS}=10\text{V}$		23		nC
		$V_{DS}=20\text{V}, I_D=13.5\text{A}, V_{GS}=4.5\text{V}$		12		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=20\text{V}, I_D=13.5\text{A}$, $V_{GS}=10\text{V}$		2		nC
Q _{gd}	Gate-Drain Charge			6.2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=3\text{A}$		0.78	1.2	V
Notes						
a.Guaranteed by design, not subject to production testing.						
b.Drain current limited by maximum junction temperature.						
c.Starting $T_J=25^\circ\text{C}$, $L=0.5\text{mH}$, $V_{DD}=20\text{V}$. (See Figure13)						
d.Mounted on FR4 Board of 1 inch ² , 2oz.						

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Die 1

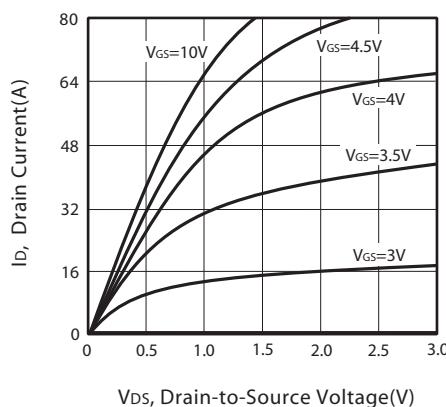


Figure 1. Output Characteristics

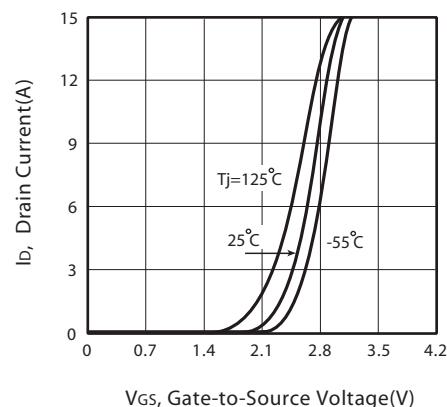


Figure 2. Transfer Characteristics

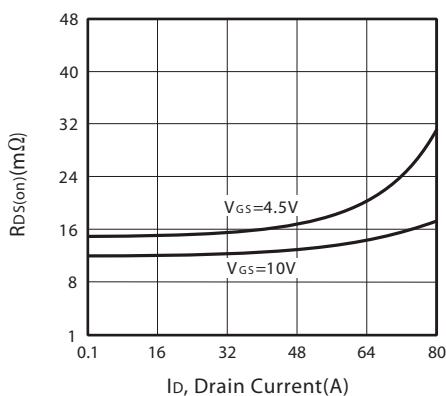


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

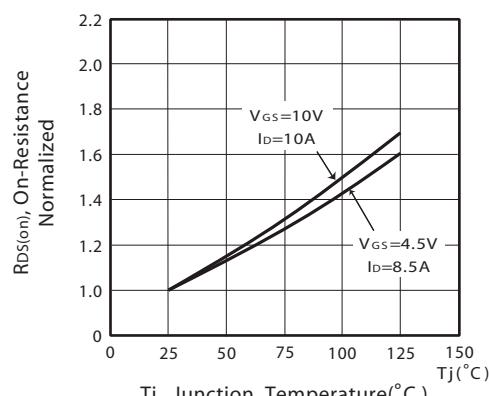


Figure 4. On-Resistance Variation with Drain Current and Temperature

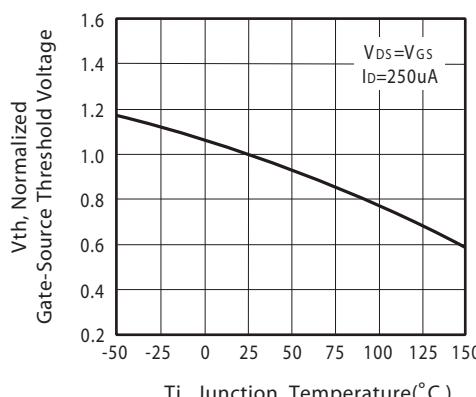


Figure 5. Gate Threshold Variation with Temperature

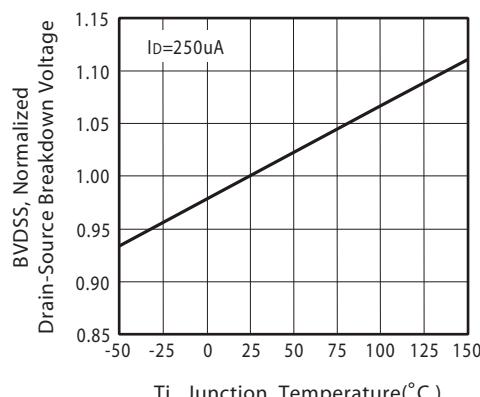


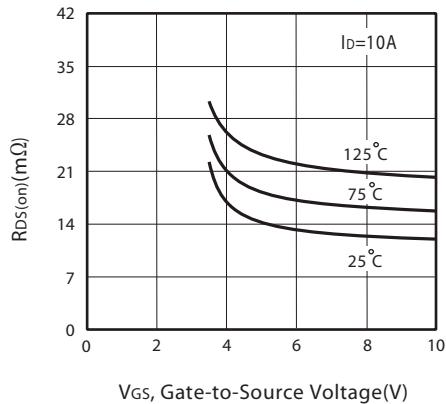
Figure 6. Breakdown Voltage Variation with Temperature

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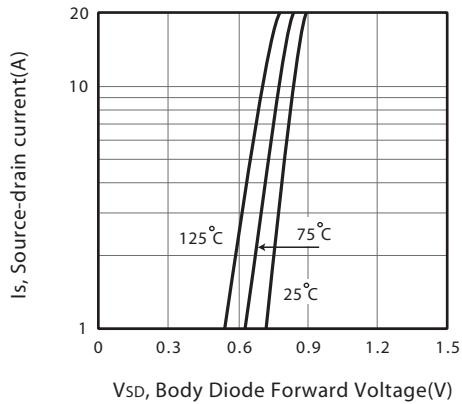
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Die 1



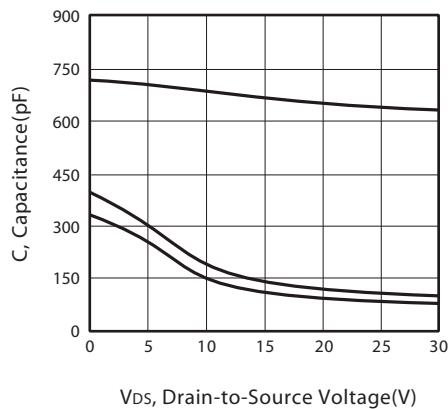
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



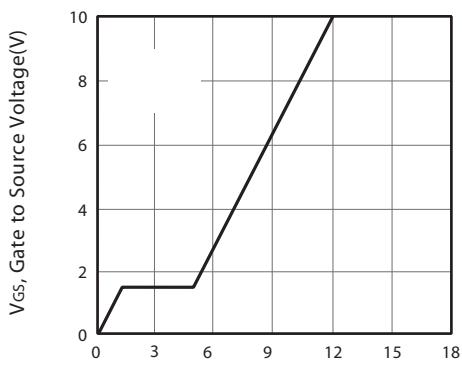
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



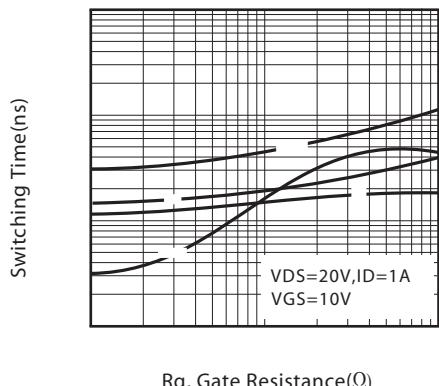
V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q_g, Total Gate Charge(nC)

Figure 10. Gate Charge



R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

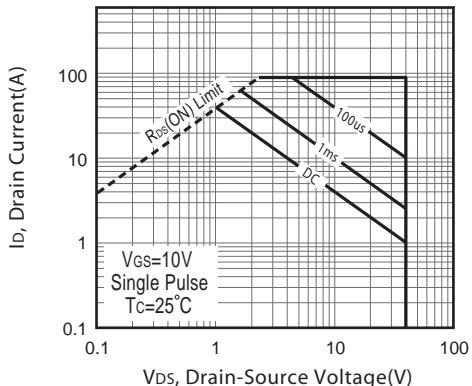


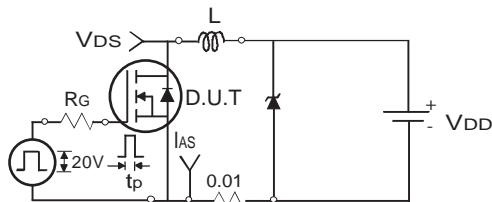
Figure 12. Maximum Safe Operating Area

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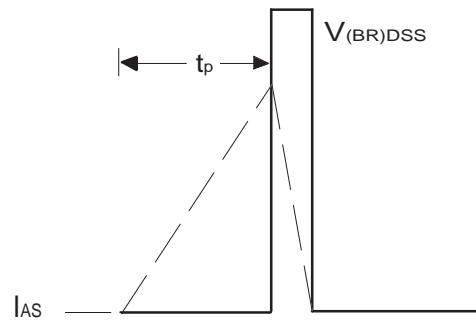
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Die 1



Uncamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

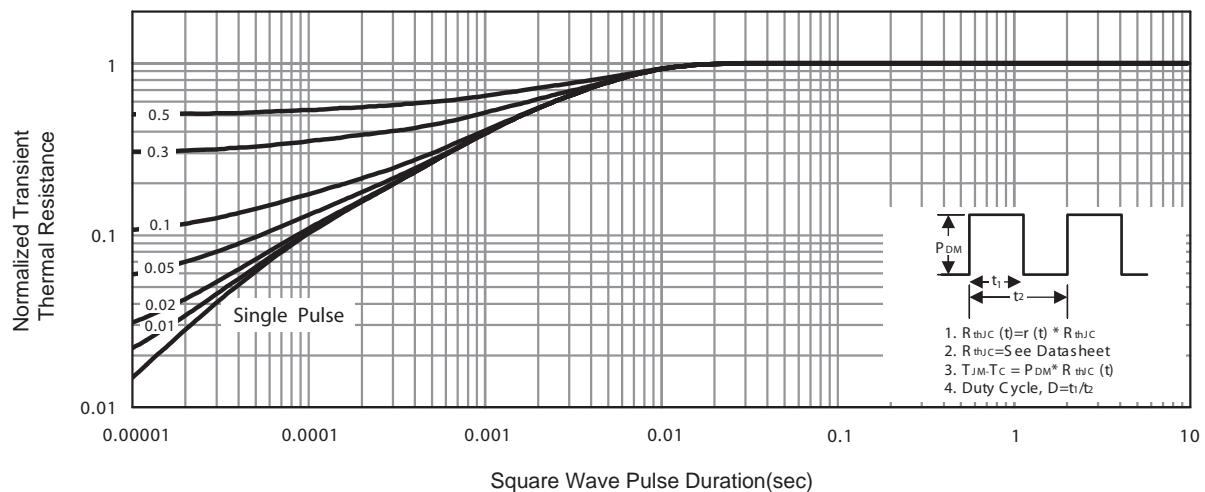


Figure 14. Normalized Thermal Transient Impedance Curve

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Die 2

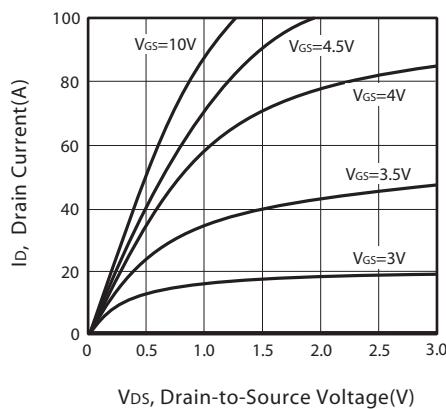


Figure 1. Output Characteristics

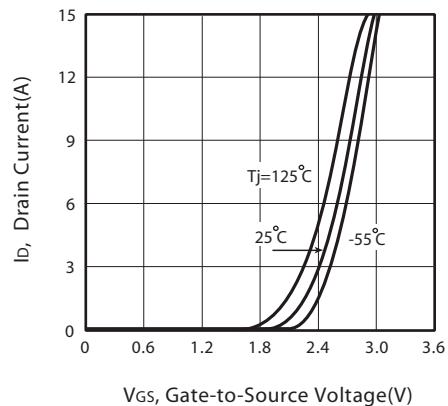


Figure 2. Transfer Characteristics

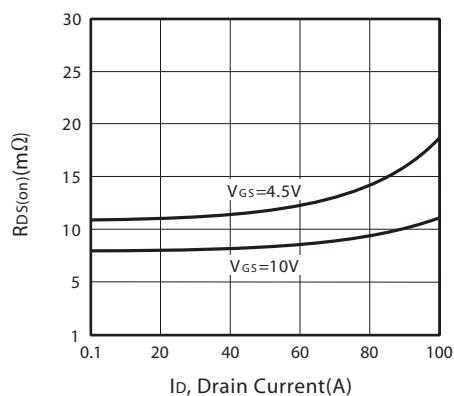


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

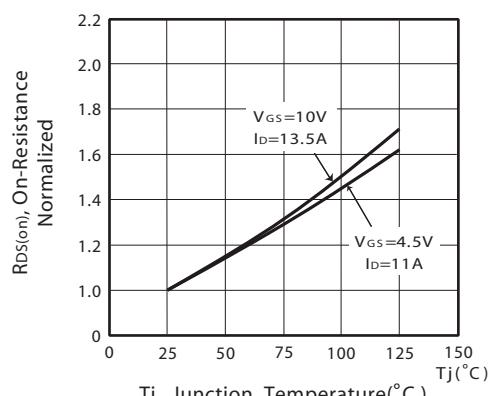


Figure 4. On-Resistance Variation with Drain Current and Temperature

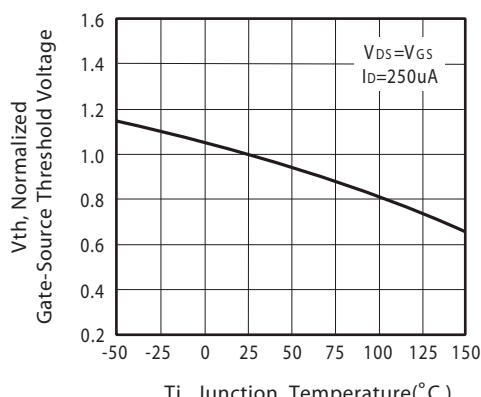


Figure 5. Gate Threshold Variation with Temperature

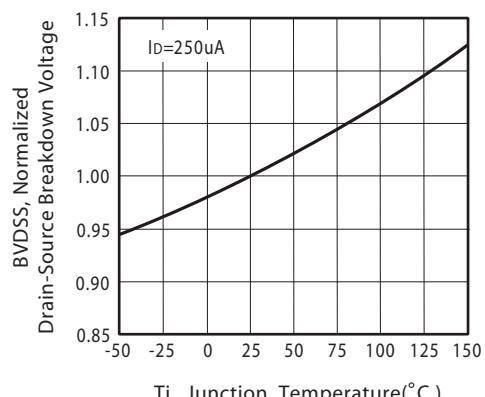


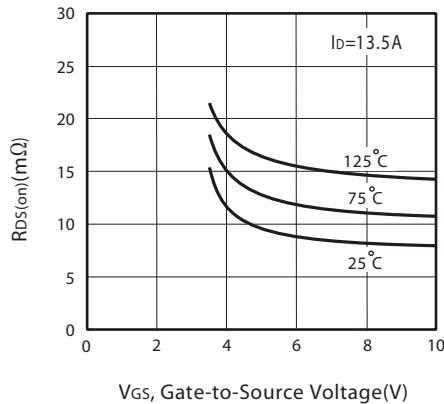
Figure 6. Breakdown Voltage Variation with Temperature

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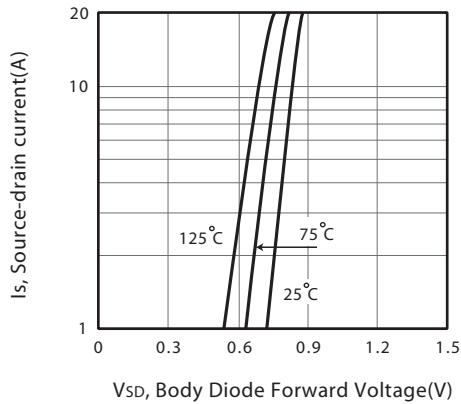
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Die 2



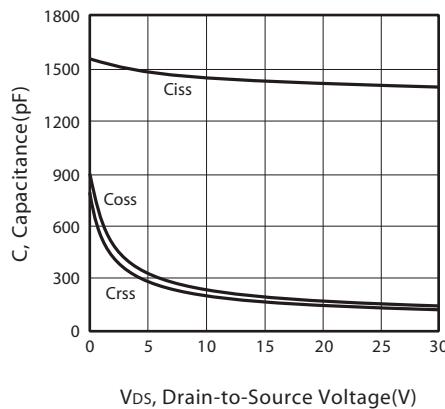
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



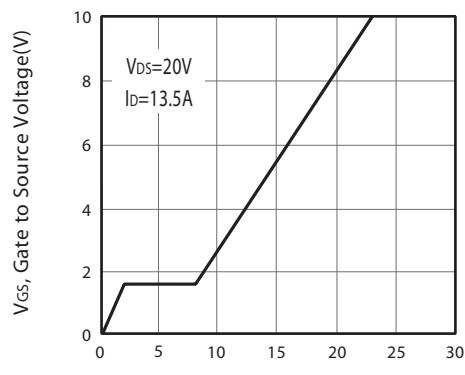
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



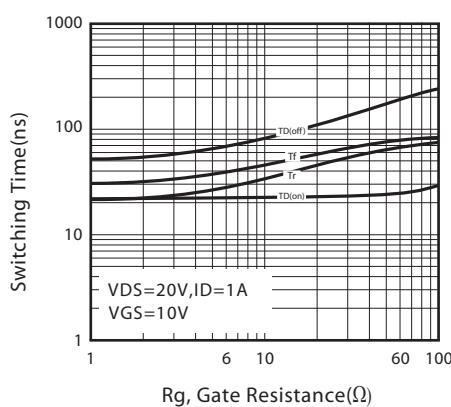
V_{DS}, Drain-to-Source Voltage(V)

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Q_g, Total Gate Charge(nC)

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R_g, Gate Resistance(Ω)

Figure 11. switching characteristics

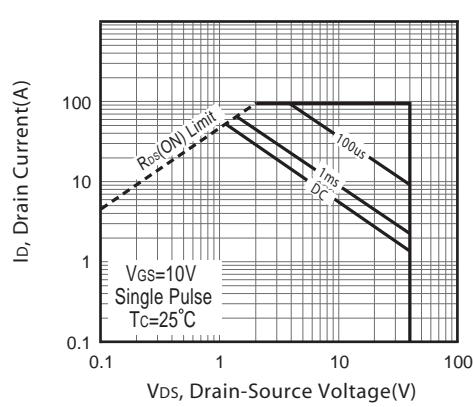


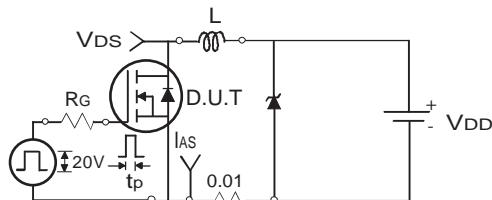
Figure 12. Maximum Safe Operating Area

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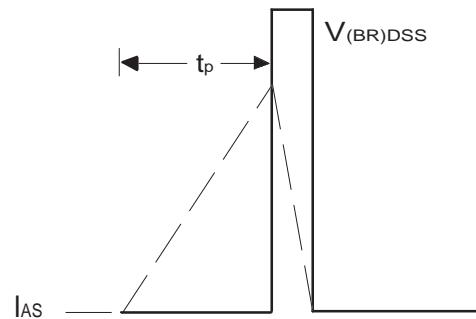
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Die 2



Uncamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

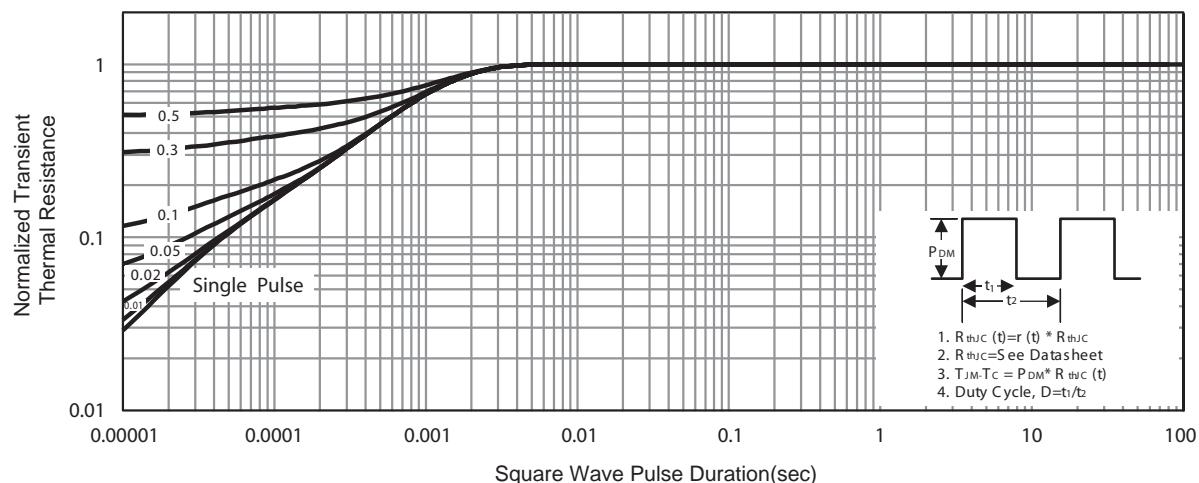
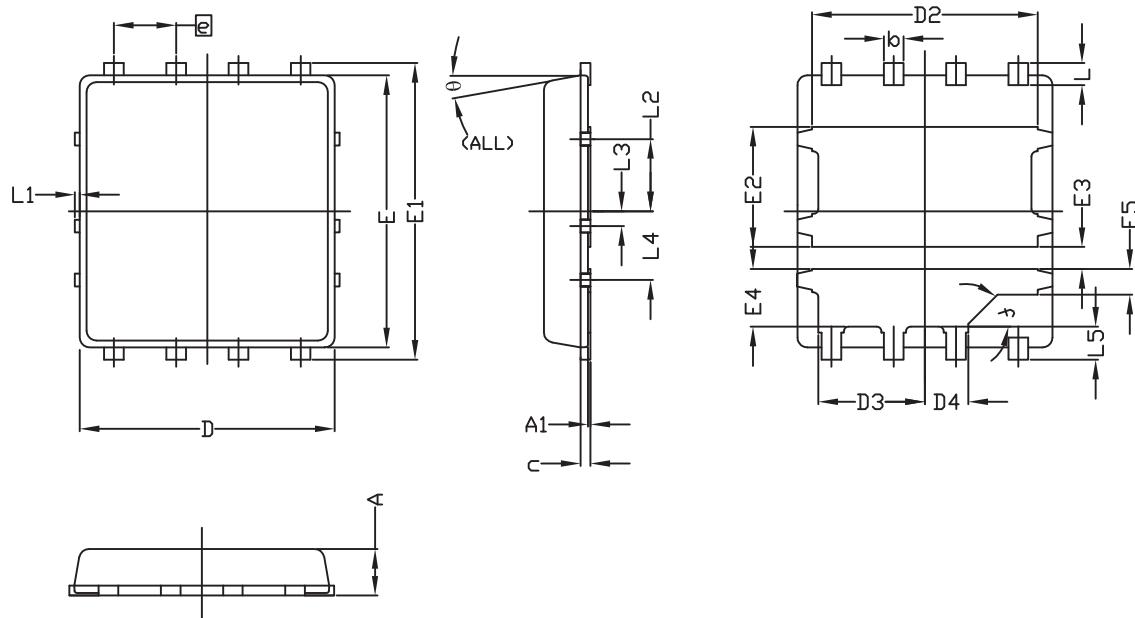


Figure 14. Normalized Thermal Transient Impedance Curve

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PACKAGE OUTLINE DIMENSIONS

PDFN 5x6-8L



SYMBOLS	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.90	1.00	0.033	0.035	0.039
A1	0.00	—	0.05	0.000	—	0.002
b	0.35	0.40	0.45	0.014	0.016	0.018
c	0.15	0.20	0.25	0.006	0.008	0.010
D	5.20 BSC			0.205 BSC		
D2	4.50	4.60	4.70	0.177	0.181	0.185
D3	2.125	2.175	2.225	0.084	0.086	0.088
D4	0.835	0.885	0.935	0.033	0.035	0.037
E	5.55 BSC			0.219 BSC		
E1	6.05 BSC			0.238 BSC		
E2	2.40	2.45	2.50	0.094	0.096	0.098
E3	0.40	0.45	0.50	0.016	0.018	0.020
E4	1.125	1.175	1.225	0.044	0.046	0.048
E5	0.475	0.525	0.575	0.019	0.021	0.023
e	1.27 BSC			0.050 BSC		
L	0.35	0.45	0.55	0.014	0.018	0.022
L1	0.00	—	0.10	0.000	—	0.004
L2	1.375	1.475	1.575	0.054	0.058	0.062
L3	0.20	0.30	0.40	0.008	0.012	0.016
L4	1.30	1.40	1.50	0.051	0.055	0.059
L5	0.575	0.675	0.775	0.023	0.027	0.031
f	45°			45°		
θ	0°	—	10°	0°	—	10°

TOP MARKING DEFINITION

PDFN 5x6-8L

